

Features

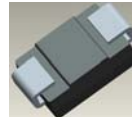
- Glass Passivated Die Construction
- Ultra-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- High Current Capability
- Ideally Suited for Automated Assembly
- **Lead-Free Finish; RoHS Compliant (Note 1)**
- **Halogen and Antimony Free. "Green" Device (Note 2)**

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.064 grams (Approximate)



Top View



Bottom View

Ordering Information (Note 3)

| Part Number* | Case | Packaging |
|--------------|------|-------------------|
| US1x-13-F | SMA | 5,000/Tape & Reel |

*x = Device type, e.g. US1A-13-F.

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Marking Information



US1x = Product Type Marking Code, ex: US1A
 DII = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 4 for 2014)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | US1A | US1B | US1D | US1G | US1J | US1K | US1M | Unit |
|--|---------------------|------|------|------|------|------|------|------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | | | | | | | | |
| Working Peak Reverse Voltage | V _{RWM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| DC Blocking Voltage (Note 4) | V _R | | | | | | | | |
| RMS Reverse Voltage | V _{R(RMS)} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ T _T = +75°C | I _O | 1.0 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 30 | | | | | | | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Maximum Thermal Resistance, Junction to Terminal | R _{θJT} | 30 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

| Characteristic | Symbol | US1A | US1B | US1D | US1G | US1J | US1K | US1M | Unit |
|---|-----------------|------|------|------|------|------|------|------|------|
| Forward Voltage Drop @ I _F = 1.0A | V _{FM} | 1.0 | | | 1.3 | 1.7 | | | V |
| Peak Reverse Current @ T _A = +25°C at Rated DC Blocking Voltage (Note 4) @ T _A = +100°C | I _{RM} | | | | 5.0 | | | | μA |
| Reverse Recovery Time (Note 5) | t _{rr} | 50 | | | 75 | | | ns | |
| Typical Total Capacitance (Note 6) | C _T | 20 | | | 10 | | | pF | |

- Notes: 4. Short duration pulse test used to minimize self-heating effect.
5. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See Figure 5.
6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

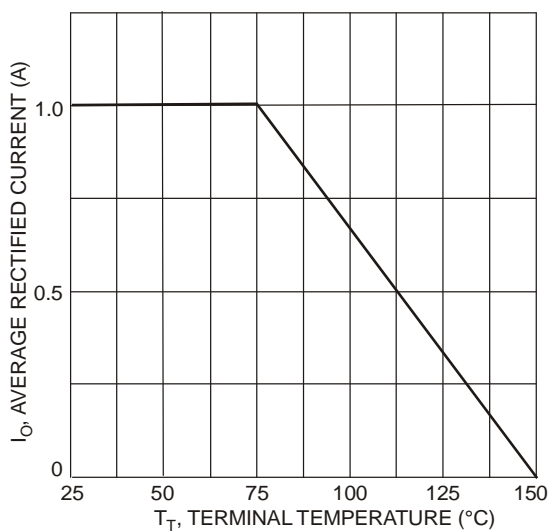


Fig. 1 Forward Current Derating Curve

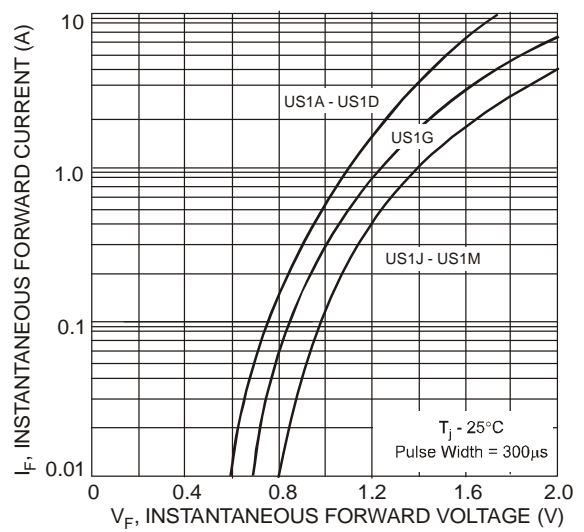


Fig. 2 Typical Forward Characteristics

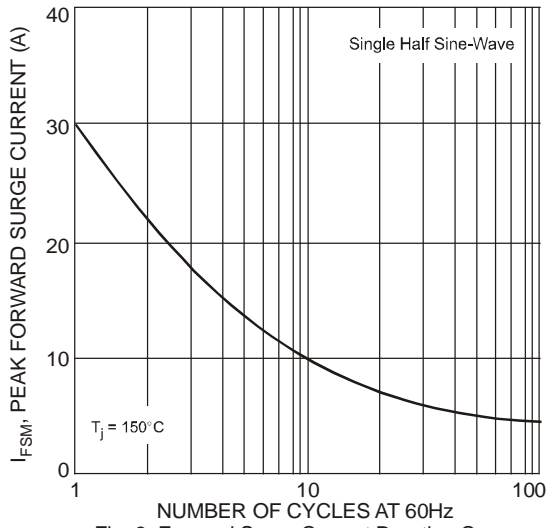


Fig. 3 Forward Surge Current Derating Curve

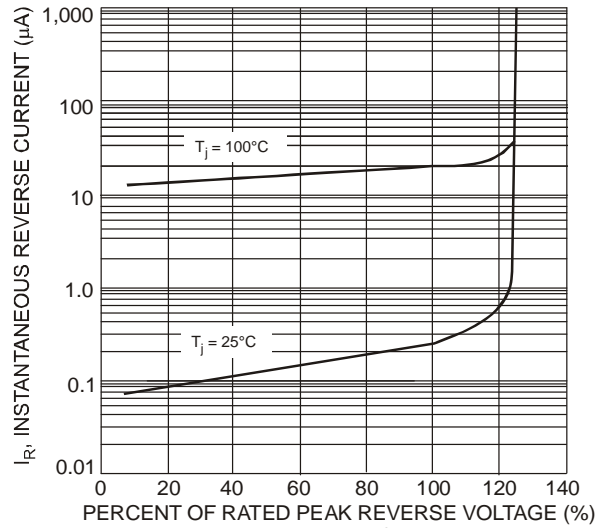
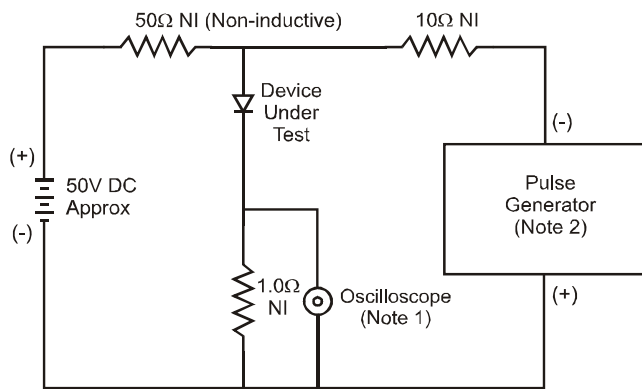
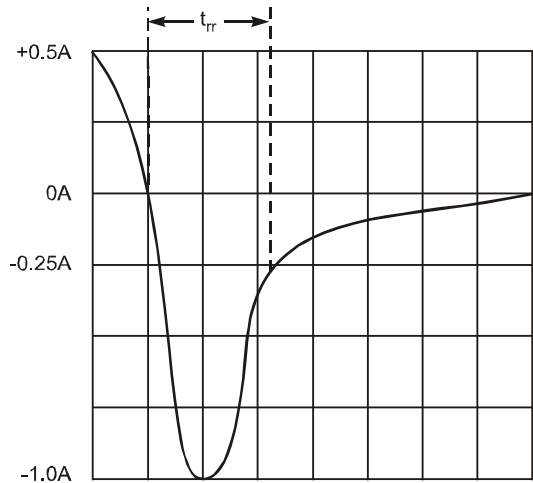


Fig. 4 Typical Reverse Characteristics



- Notes:
1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.
 2. Rise Time = 10ns max. Input Impedance = 50Ω.

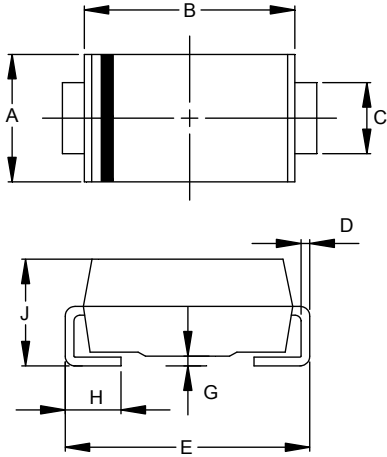


Set time base for 50/100 ns/cm

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

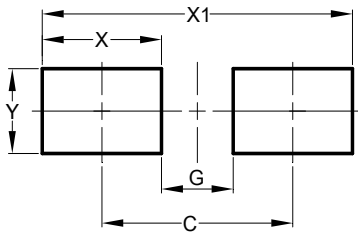


| SMA | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 2.29 | 2.92 |
| B | 4.00 | 4.60 |
| C | 1.27 | 1.63 |
| D | 0.15 | 0.31 |
| E | 4.80 | 5.59 |
| G | 0.05 | 0.20 |
| H | 0.76 | 1.52 |
| J | 1.96 | 2.40 |
| All Dimensions in mm | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.

SMA



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 4.00 |
| G | 1.50 |
| X | 2.50 |
| X1 | 6.50 |
| Y | 1.70 |

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